

HVC300B

Variable Capacitance Diode for VHF tuner

REJ03G0097-0200Z
(Previous: ADE-208-603)
Rev.1.00
Sep.23.2003

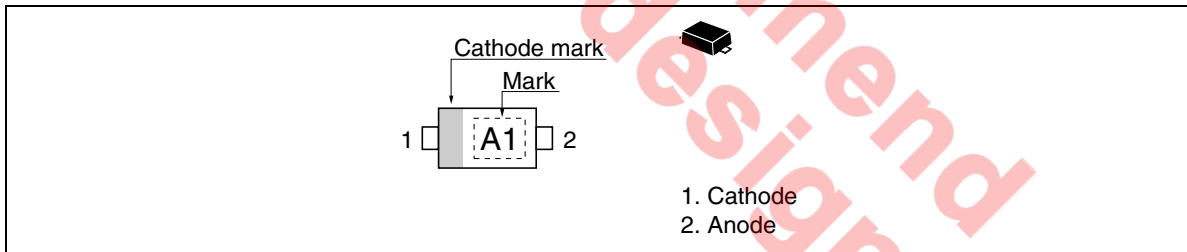
Features

- Low matching error. ($\Delta C/C = 2.0\%$ max)
- High capacitance ratio. ($n = 17.0$ min)
- Low series resistance. ($r_s = 1.1 \Omega$ max)
- Ultra small Flat Package (UFP) is suitable for surface mount design.

Ordering Information

Type No.	Laser Mark	Package Code
HVC300B	A1	UFP

Pin Arrangement



Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Peak reverse voltage	V_{RM}^{*1}	35	V
Reverse voltage	V_R	34	V
Junction temperature	Tj	125	°C
Storage temperature	Tstg	-55 to +125	°C

Note: 1. $R_L = 10\text{ k}\Omega$

Electrical Characteristics

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse current	I_{R1}	—	—	10	nA	$V_R = 32\text{ V}$
	I_{R2}	—	—	100		$V_R = 32\text{ V}, T_a = 60^\circ\text{C}$
Capacitance	C_2	47.0	—	53.0	pF	$V_R = 2\text{ V}, f = 1\text{ MHz}$
	C_{25}	2.65	—	3.0		$V_R = 25\text{ V}, f = 1\text{ MHz}$
Capacitance ratio	n	17.0	—	—	—	C_2/C_{25}
Series resistance	r_s	—	—	1.1	Ω	$V_R = 5\text{ V}, f = 470\text{ MHz}$
Matching error	$\Delta C/C^{*1}$	—	—	2.0	%	$V_R = 2\text{ to }25\text{ V}, f = 1\text{ MHz}$

Note: 1. C.C system (Continuous Connected taping system) enable to make any 10 pcs of $\Delta C/C$ continuous in a reel, expect extention to another group.
Calculate Matching Error,

$$\Delta C/C = \frac{(C_{\max} - C_{\min})}{C_{\min}} \times 100 (\%)$$

Main Characteristic

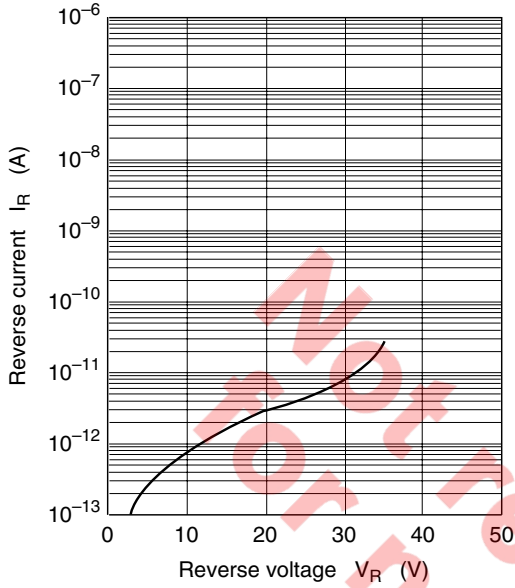


Fig.1 Reverse current vs. Reverse voltage

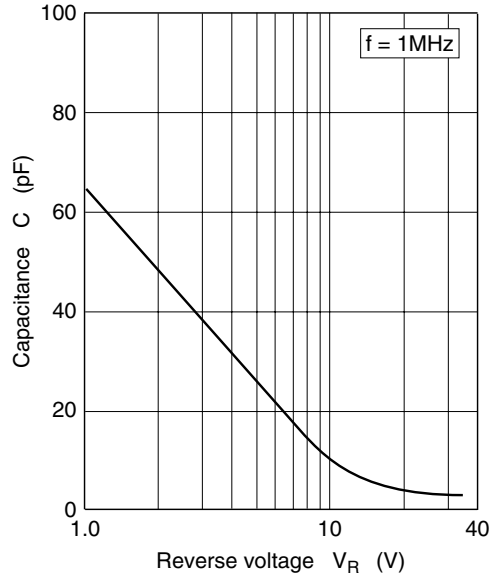


Fig.2 Capacitance vs. Reverse voltage

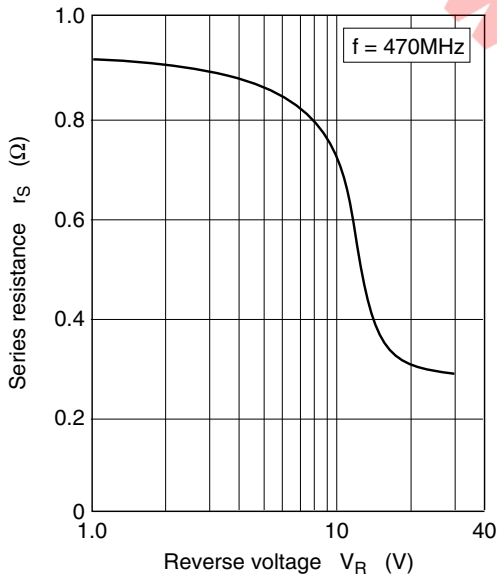


Fig.3 Series resistance vs. Reverse voltage

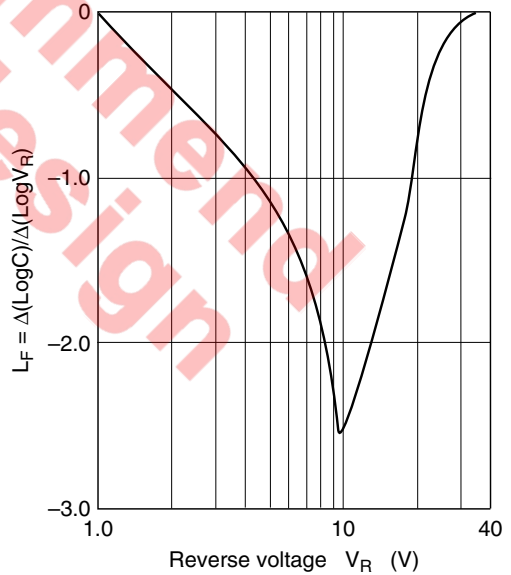
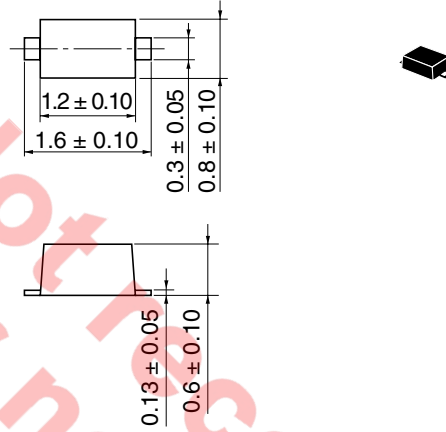


Fig.4 Linearity factor vs. Reverse voltage

Package Dimensions

As of January, 2003
Unit: mm



Package Code	UFP
JEDEC	—
JEITA	Conforms
Mass (reference value)	0.0016 g

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Renesas Technology America, Inc.
450 Holger Way, San Jose, CA 95134-1368, U.S.A
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Renesas Technology Europe Limited.
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, United Kingdom
Tel: <44> (1628) 585 100, Fax: <44> (1628) 585 900

Renesas Technology Europe GmbH
Dornacher Str. 3, D-85622 Feldkirchen, Germany
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Renesas Technology Hong Kong Ltd.
7/F., North Tower, World Finance Centre, Harbour City, Canton Road, Hong Kong
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Renesas Technology Taiwan Co., Ltd.
FL 10, #99, Fu-Hsing N. Rd., Taipei, Taiwan
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Renesas Technology (Shanghai) Co., Ltd.
26/F., Ruijin Building, No.205 Maoming Road (S), Shanghai 200020, China
Tel: <86> (21) 6472-1001, Fax: <86> (21) 6415-2952

Renesas Technology Singapore Pte. Ltd.
1, Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632
Tel: <65> 6213-0200, Fax: <65> 6278-8001